



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.: 10/511,792 Confirmation No.: 6292
Applicant(s): Radenne et al.
Filed: 5/9/2005
Art Unit: 2815
Examiner: Chu, Chris C.
Title: Method For Encapsulation Of A Chipcard And Module
Obtained Thus

Attorney Docket No.: 003D.0032.U1(US)
Customer No.: 29,683

Commissioner For Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Amendment

Sir:

This is in response to the Office Action mailed 09/25/2006 in regard to the above-identified patent application. Please amend the Application as indicated on the following pages. Enclosed is a check for \$250.00 as payment of the extra claim fees. Please charge deposit account 50-1924 for any fee deficiency.

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begin on page 3 of this paper.

Remarks begin on page 9 of this paper.

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